## 505177929 11/06/2018

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5224697

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
KEUN HEE BAI	09/11/2018
SUNG WOO KANG	09/17/2018
KEE SANG KWON	09/17/2018
DONG SEOK LEE	09/11/2018
SANG HYUN LEE	09/17/2018
JEONG YUN LEE	09/17/2018
YONG-HO JEON	09/14/2018

#### **RECEIVING PARTY DATA**

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State/Country:	KOREA, REPUBLIC OF
Postal Code:	16677

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16176943

#### **CORRESPONDENCE DATA**

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NAME OF SUBMITTER:	BRADLEY EDELMAN, REG. NO. 57648
SIGNATURE:	/Bradley Edelman/
DATE SIGNED:	11/06/2018

PATENT REEL: 047425 FRAME: 0704

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## **Total Attachments: 5**

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PATENT REEL: 047425 FRAME: 0705

# COMBINED DECLARATION (37 CFR §1.63) FOR UTILITY PATENT APPLICATION AND ASSIGNMENT FORM<sup>1</sup>

The undersigned acknowledges that this document is being used both as an assignment of the invention and as the declaration (37 CFR 1.63) for a Utility or Design Application.

WHEREAS, the undersigned, hereinafter referred to collectively as Assignor, has invented:

***************************************	is, the undersigned, hereinated referred to concertvely as 7 issigner, has invented.
Title:	SEMICONDUCTOR DEVICE INCLUDING SELF-ALIGNED CONTACT AND METHOD OF FABRICATING THE SEMICONDUCTOR DEVICE
for which	h Assignor is about to make or has made United States or International application
WHEREA	s, as a below named inventor(s), I/(we) hereby declare that:
Section I	l. Declaration
This decl	laration is directed to:
	The attached U.S. non-provisional patent application, or
	U.S. non-provisional patent application number, filed on, or
	PCT international patent application number, filed on
The abov	ve-identified application was made or authorized to be made by me (us).
	elieve that I am (we are) the original inventor (original joint inventors) of a claimed in the above-identified application.
	reby acknowledge that any willful false statement made in this declaration is ole under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or
<sup>1</sup> This for	m requires the use of an Application Data Sheet.
SEC Ref	No. <u>IE-201711-036-1-US0</u> Attorney Ref No. <u>SAM-56176</u>

COMBINED DECLARATION (37 CFR 1.63) FOR UTILITY PATENT APPLICATION AND ASSIGNMENT FORM Page 1 of 5 PATENT

I hereby state that I have reviewed and understand the contents of the above identified application, including the claims.

I acknowledge that I am aware of the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56.

#### Section II. Assignment

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned, the undersigned hereby sell(s) and assign(s) to

Samsung Electronics Co., Ltd.

having an address at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do 16677, Republic of Korea (hereinafter designated as the Assignee), the entire (100%) right, title and interest for the United States as defined in 35 USC §100, in the invention described in the application identified in Section I of this document.

Assignor hereby confirms any prior assignment to Assignee, and to the extent that Assignor has not already done so, agrees to assign, and hereby does, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by Assignor had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights;

Assignor hereby covenants and agrees to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, reexamination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters

SEC Ref No.	IE-201711-036-1-US0	Attorney Ref No.	SAM-56176

REEL: 047425 FRAME: 0707

Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

Assignor hereby covenants that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment; and

Assignor hereby requests the United States Patent and Trademark Office to issue the Letters Patent of the United States of America to Assignee, and requests that any official of any country or countries foreign to the United States, whose duty it is to issue or grant patents and applications as aforesaid, to issue the Letters Patent, Utility Model Registration or other similar right to Assignee.

The undersigned hereby grant(s) the law firm of Muir Patent Law, PLLC the power to insert on this Declaration and Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

# Section III. Inventor(s)/Assignor(s) Signature(s)

LEGAL NAME OF FIRST	Family Name	First Given Name	Second Given Name
INVENTOR/ASSIGNOR	BAI	Keun Hee	
	* '		1
SIGNATURE	Butt	DATE	2019, 3, 11
	<u> </u>	<del>-</del> 0788-2010 070 070 076	<u> </u>

LEGAL NAME OF L	Family Name	First Given Name	Second Given Name
INVENTOR/ASSIGNOR	KANG	Sung Woo	444
	. A. S.	DATE	<b>*</b>
SIGNATURE /	roff.		<u> </u>

LEGAL NAME C	)F	Family Name	First Given Name	Secon	d Given Name
M0000000000000000000000000000000000000	L	**************************************			
SEC Ref No.		711-036-1-US0	Attorney Ref No.		I-56176

THIRD INVENTOR/ASSIGNOR	KWON	Kee Sang	
SIGNATURE	7176	DATE	2413,9,17
LEGAL NAME OF	Family Name	First Given Name	Second Given Name
FOURTH INVENTOR/ASSIGNOR	<b>LEE</b>	Dong Seok	
SIGNATURE	Mala	DATE	2018. 9. 11.
		f	Tree control
LEGAL NAME OF	Family Name	First Given Name	Second Given Name
FIFTH INVENTOR/ASSIGNOR	TEE	Sang Hyun	
SIGNATURE		/88 - 6 8 / 020 / 3 <b>DATE</b>	28 8,9-17
LEGAL NAME OF	Family Name	First Given Name	Second Given Name
SIXTH	i anny manie	inst olven name	Second Given Name
INVENTOR/ASSIGNOR	LEE	Jeong Yun	
SIGNATURE	Lar	DATE	2018.9.17
	<del></del>		1
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SEVENTH	JEON	Yong-Ho	
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공정개발1팀(반도체연)/배근회/02073076/2018-09-11 05:44 Page 4 of 5 PATENT

SAMSUNG ELECTRONICS CO., LTD.

INVENTOR/ASSIGNOR			
SIGNATURE	DATE	<b>2018</b> 1	<u>3.14</u>

罗智河南下县(曾5.41至)/明己海/02079076

SEC Ref No. <u>IE-201711-036-1-US0</u> Attorney Ref No. <u>SAM-56176</u>